

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Art Unit 1711

Brian Labrec

Confirmation No. 4087

Application No.: 10/677,092

Filed: September 30, 2003

For: INCREASING THERMAL CONDUCTIVITY
OF HOST POLYMER USED WITH LASER
ENGRAVING METHODS AND
COMPOSITIONSVIA ELECTRONIC FILING

Examiner: S. McClendon

Date: September 15, 2008

INFORMATION DISCLOSURE STATEMENT

MAIL STOP RCE
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

Applicants submit herewith information of which they are aware, and which they believe may be material to the examination of the application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R. § 1.56. The information is listed on the attached Form PTO-1449 and copies of the Other References are attached.

The submission of information on the attached Form PTO-1449 is not intended as an admission that any such information constitutes prior art against the claims of the application under examination. Applicants do not waive any right to take any appropriate action to antedate or otherwise remove any information from the attached Form PTO-1449.

No fee is required since this document is being submitted with a Request for Continued Examination.

If a fee is required, please charge to Deposit Account No. 50-1071 any fees that may be required for considering this Information Disclosure Statement under 37 C.F.R. § 1.17(p).

Respectfully submitted,

Date: September 15, 2008

DIGIMARC CORPORATION

CUSTOMER NUMBER 23735

Phone: 503-469-4800
FAX 503-469-4777

By /Joel R. Meyer/
Joel R. Meyer
Registration No. 37,677